CX3499863 | 150T135WP1800TAPE 2K' COEX



ConQuest® Empty Conduit, 1 1/2 in, SDR 13.5, terracotta, with pull tape

Product Classification	
Product Type	Empty conduit
Product Brand	ConQuest®
General Specifications	
Color	Terracotta
Conduit Type	Non-toneable
Density Test Method	ASTM D792A
Density, maximum	0.955 g/cm³ 0.035 lb/in³
Density, minimum	0.941 g/cm³ 0.034 lb/in³
Design Standard	ASTM D3350-05
Wall Type	Smooth
Dimensions	
Length	609.6 m 2000 ft
Inner Diameter, nominal	40.589 mm 1.598 in
Outer Diameter, nominal	48.26 mm 1.9 in
Wall Thickness Designation	SDR 13.5
Wall Thickness, minimum	3.581 mm 0.141 in
Nominal Size	1-1/2 in
Material Specifications	
Flexural Modulus, minimum	551.581 N/mm² 80000 psi
Flexural Property Test Method	ASTM D790
Hydrostatic Design Basis	Not pressure rated
Hydrostatic Design Test Method	ASTM D2837
Material Type	High density polyethylene (HDPE) Polyester
Melt Flow Rate Test Method	ASTM D1238

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Melt Flow Rate, maximum	0.39 g/10 min
Mechanical Specifications	
Minimum Bend Radius, unsupported	508 mm 20 in
Tensile Property Test Method	ASTM D638
Tensile Strength at yield, minimum	20.684 N/mm ² 3000 psi
Breaking Strength	816.466 kg 1800 lb
Pull Line Type	Таре
Pulling Tension, maximum	659.977 kg 1455 lb

Environmental Specifications

Environmental Stress Crack Resistance	Failure rate of 10% within 96 hours
Environmental Stress Test Method	ASTM D1693, ESCR Condition B

Packaging and Weights

Weight, net

511.928 kg/km | 344 lb/kft

Regulatory Compliance/Certifications

Agency	Classification
ISO 9001:2015	Designed, manufactured and/or distributed under this quality management system

* Footnotes

Environmental Stress Crack Resistance ESCR-Environmental Stress Crack Resistence

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